

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of : Customer Number: 89518
Mou-Shiung Lin, et al. : Confirmation Number: 1870
Application No.: 10/796,427 : Group Art Unit: 2894
Patent No.: 7,470,997 : Issued: December 30, 2008
For: WIREBOND PAD FOR SEMICONDUCTOR CHIP OR WAFER

TRANSMITTAL OF POWER OF ATTORNEY

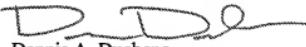
Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Transmitted herewith is a Fee Address Indication Form, Power Of Attorney to Prosecute Applications Before the USPTO, together with a Statement Under 37 CFR 3.73(b), which revokes all previous powers of attorney given in the above-identified application and associates the application with Customer Number 89518.

Respectfully submitted,

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**Please recognize our Customer No. 89518
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